

Taiwan Semiconductor

2A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

Case: SOD-128

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

• Weight: 0.027g (approximately)

KEY PARAMETERS			
PARAMETER VALUE U			
I _F	2	А	
V_{RRM}	200 - 1000	V	
I _{FSM}	50	Α	
T _{J MAX}	150 °C		
Package	SOD-128		
Configuration	Single die		





SOD-128



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	S2D FSH	S2G FSH	S2J FSH	S2K FSH	S2M FSH	UNIT
Marking code on the device			S2DFH	S2GFH	S2JFH	S2KFH	S2MFH	
Repetitive peak reverse volta	ige	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms va	lue	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I _F	2				Α	
Surge peak forward current, single half sine-wave	t = 8.3ms				50			А
superimposed on rated load $t = 1.0$ m		I _{FSM}	140				Α	
Junction temperature		T _J	-55 to +150		°C			
Storage temperature		T _{STG}	-55 to +150		°C			



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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	14	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	74	°C/W	
Junction-to-case thermal resistance	R _{eJC}	20	°C/W	

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 1A, T _J = 25°C		0.91	-	V
	I _F = 2A, T _J = 25°C	V _F	0.98	1.10	V
	I _F = 1A, T _J = 125°C		0.79	-	V
	I _F = 2A, T _J = 125°C		0.88	0.98	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	I _R	-	1	μΑ
	T _J = 125°C		-	33	μA
Junction capacitance	1MHz, V _R = 4.0V	CJ	12	-	pF

Notes:

- (1) Pulse test with PW = 0.3ms
- (2) Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
S2xFSH	SOD-128	14,000 / Tape & Reel		

Notes:

(1) "x" defines voltage from 200V(S2DFSH) to 1000V(S2MFSH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

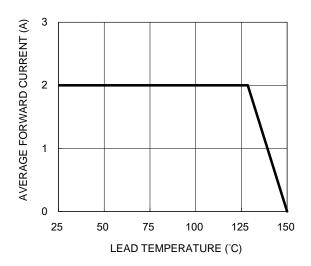


Fig.3 Typical Reverse Characteristics

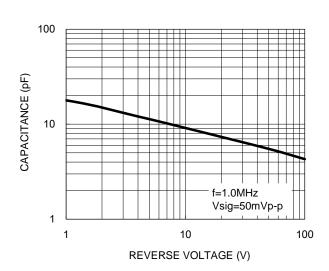
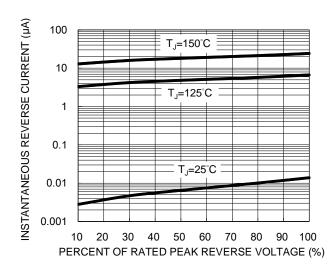


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



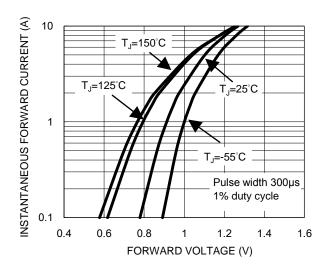
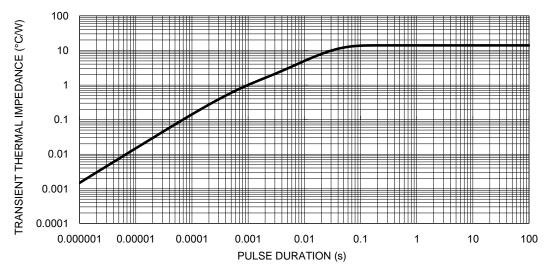


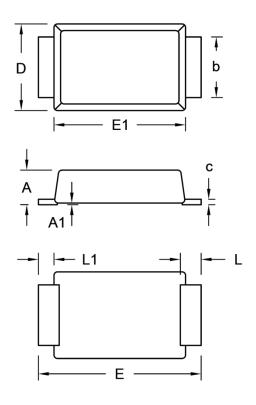
Fig.5 Typical Transient Thermal Impedance





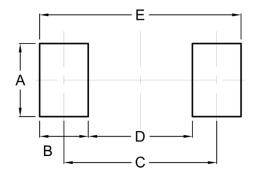
PACKAGE OUTLINE DIMENSIONS

SOD-128



DIM.	Unit (mm)		Unit (inch)	
DIIVI.	Min.	Max.	Min.	Max.	
А	0.90	1.10	0.035	0.043	
A1	0.00	0.10	0.000	0.004	
b	1.60	1.90	0.063	0.075	
С	0.10	0.22	0.004	0.009	
D	2.30	2.70	0.091	0.106	
E	4.40	5.00	0.173	0.197	
E1	3.60	4.00	0.142	0.157	
L	0.40	0.80	0.016	0.031	
L1	0.30	0.60	0.012	0.024	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code F = Factory Code



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